

333HRD-3

Light Emitting Diode

Description

• Size: 5mm (T1 3/4) round package.

Emitting color: Super red.

Lens color: Red color diffused.

Lead type: Radial leads.

Main Features

Instant light less than 100ns turn on time.

Superior resistance to moisture.

 Low drive current, recommend forward current: IF= 10-20mA. Pb-Free

Cool beam, safe to touch.

Reliable and rugged.

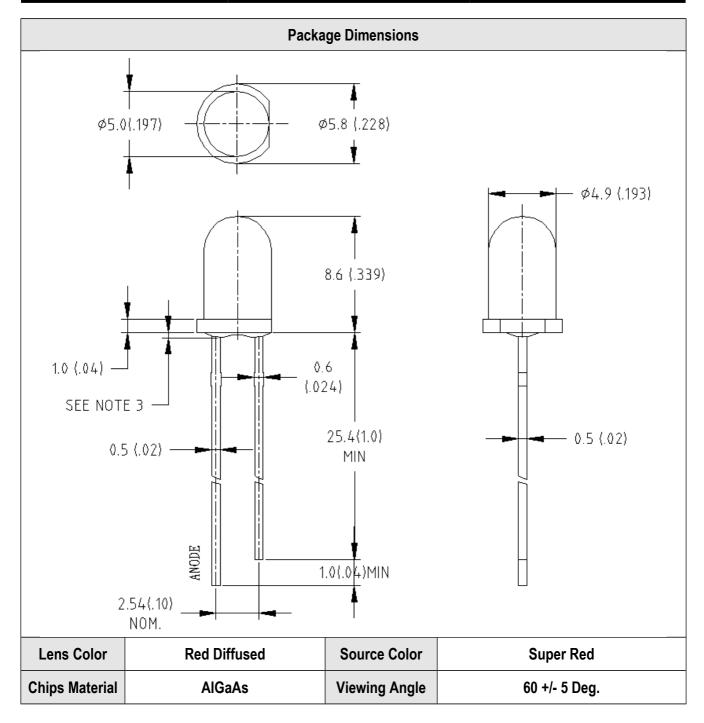
Absolute Maximum Rating TA=25°C								
Parameter	Symbol	Rating	Unit	Notice				
Power Dissipation	Pd	90	mW					
DC Forward Current	lF	25	mA					
Pulse Forward Current	IF (PEAK)	100	mA	Duty 1/10 @ 1KHz				
Derating Linear From 50°C		0.4	mA / °C					
Reverse Voltage	VR	5	V	Under 100uA				
Operating Temperature Range	T OPR	-25 to +70	°C					
Storage Temperature Range	T stg	-40 to +80	°C	Humidity should be under 50%				
Lead Soldering Temperature	T sol	260 +/-5	°C	4mm (0.157") from mold body Les then 5 Second				

Part Selection Electrical / Optical Characteristics At TA-25°C									
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit.			
Forward Voltage	VF	IF =20mA	1.7	1.95	2.60	V			
Reverse Current	lr	VR =5V	_	_	10	uA			
Luminous Intensity (Note 1)	lv	IF =20mA	60	110	150	mcd			
Peak Emission Wavelength	λр	IF =20mA	655	660	665	nm			
Spectral Line Half Width	Δλ	IF =20mA	18	20	23	nm			
Dominant Wavelength (Note 2)	λd	IF =20mA	640	645	650	nm			

NOTES:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Luminous intensity is measured with all three chips simultaneously pulsed at 20mA drive current.
- 4. Forward voltage measurement allowance is +/-0.1V
- 5. Luminous intensity measurement allowance +/-10%

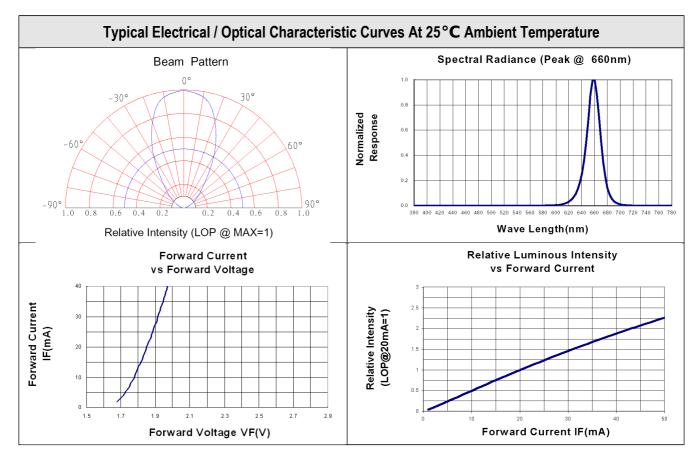




NOTES:

- All dimensions are in millimeters (inches).
- Tolerance is ±0.25 mm (.010") unless otherwise noted.
- Protruded resin under flange is 1.0mm(.04") max
- Lead spacing is measured where the leads emerge from the package.
- Specifications are subject to change without notice.





NOTE:

- $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- Clean only in isopropanol, ethanol, Freon TF (or equivalent).
- When using this product, Please observe the absolute maximum rating and the instructions for use outlined from use of the
 product, which does not comply with the absolute maximum rating and the instructions included in these specification sheet.
- Q.A Outgoing inspection standard:

Major Defect 0.65 A.Q.L. Minor Defect 1.5 A.Q.L

Check at a distance of 30cm from the LED to the eye defects.

Lead Forming:

If forming is required, it must be done before soldering. Form pin leads by securing under 5mm from body and bedding with radio pliers or the equivalent to avoid pressure on resin. When the LED is mounted into a P.C.board, pitch spacing should be aligned to prevent cause any stress to the resin. Any unsuitable stress applied to resin may break bonding wire in LED, which will cause failure.

Over-current-proof:

Customer must apply resistor for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

Parallel connection:

Customer must apply series resistor in **EACH LED** under parallel connection. Otherwise VF tolerance will cause LED array brightness uneven.

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